Specification No.	Rev. Symbol	Page	Distribution No.
LR20-D-0005		0/7	

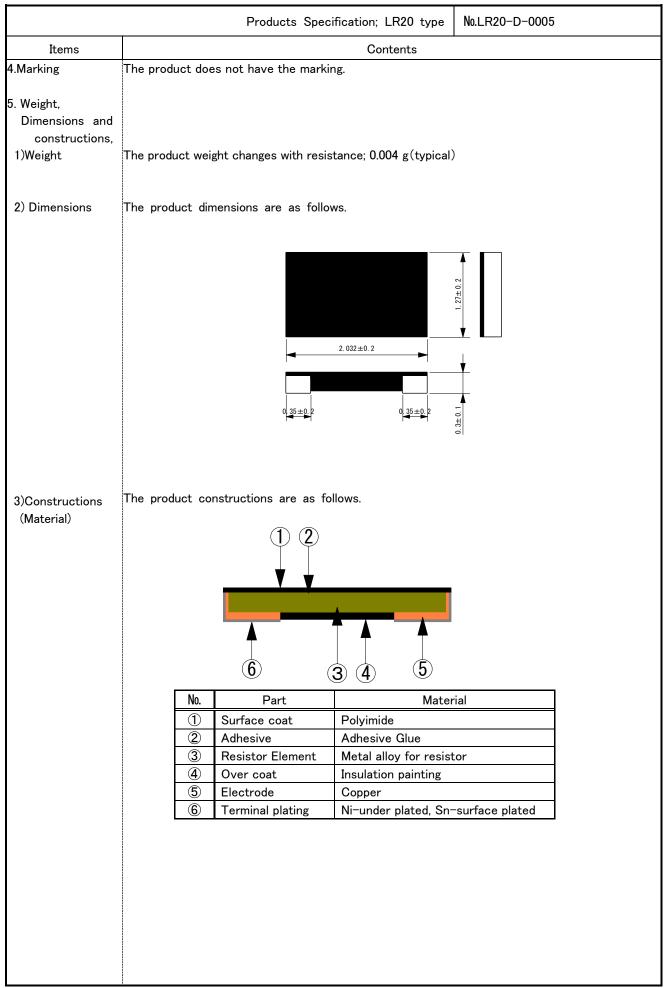
Specification

F o r CURRENT DETECTING METAL PLATE CHIP RESISTOR

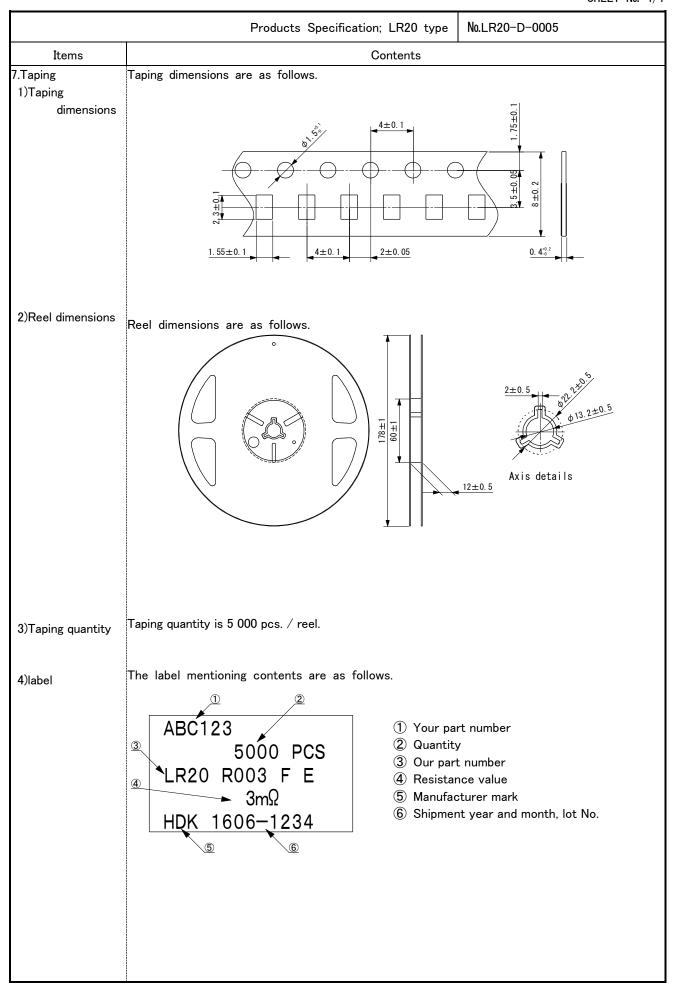
HOKURIKU ELECTRIC INDUSTRY CO., LTD. COMPONENTS DIVISION • FILM RESISTOR FACTORY

Established Date	Revised Date	Applied Date		Applied Date
1 SEP. 2016		5 SEP. 2016		5 SEP. 2016
To be kept	at	Approved	d by	S. Ueno
Engineering Section		Checked	by	M. Urayama
rngineering	Section	Drawn up by		H.Henda

1		SHEET NO. 1/1
	Products Specification; LR20 type No.LR20-	D-0005
I tems	Contents	
1.Application	This specification covers Current Detecting Metal Plate Chip Resistor	s; LR20 type.
2.Model No. designation	Model No. is designated as follows. Ex. <u>LR20</u> <u>R003</u> <u>F</u> <u>E</u> Model Nominal Tolerance Taping type resistance (Paper taping) Tolerance: Resistance tolerance is denoted by 1 alphabet capital lette	ır.
	(F → Resistance tolerance ± 1.0 %)	
3.Ratings 1)Ratings	Ratings are shown Table−1. Table−1. Ratings	
	Item Content	·s
	Nominal resistance 0.003 S	
	Resistance tolerance Class F(±1	
	Temperature coefficient ±100 ppm	
	Rated ambient temperature 70 °C	
	Operating temperature range -55 °C to 1	50 °C
	Rated wattage 0.5 W	
	*Rated wattage is the maximum continuous power applicable at ambi	ent temperature from -55
3)Rated voltage	Rated voltage is the D.C. or rms A.C. maximum voltage at ambient ten 70 °C. Rated voltage shall be determined from following formula.	
	$E = \sqrt{\langle P \times R \rangle} \qquad \qquad \begin{array}{c} E : Rated \ voltage[V] \\ P : Rated \ wattage[W] \\ R : Nominal \ resistance[\Omega] \end{array}$	



		 	Products Specification; I		N₀.LR20-D-0005		
Items		Contents					
6.Characteris-	Chara	Characteristics and test method are shown Table 2.					
tics and Test method		Table 2.Characteristics and Test method					
					Test method		
	1	Resistance	Tolerance class F;		ment current; 1 A		
	2	T	within ±1.0 % within±100 ppm/°C		d at 25 °C temperature; 25 °C		
		Temperature coefficient	within ± 100 ppm/ C		d temperature; 25 °C		
		of resistance		illeasure	temperature, 130 C		
	3	Short-time	Resistance change;	Be applie	ed electric power equal to 3 times		
		overload within ±0.5 % rated power in					
				-	01-1 4.13		
	4	Insulation	tion Over $10^9~\Omega$ Be measured at terminals an				
		resistance		resistor l	resistor by d.c.100 V±15 V in 1 min.		
				JIS C 52	01-1 4.6		
	5	Dielectric	Without breakdown	Be applied at terminals and center of			
		withstanding			resistor on a.c.100V, 1min.		
		voltage		JIS C 52			
	6	Resistance	Resistance change;		on the copper sheet (t=0.2 mm)		
		to soldering	within ±0.5 %	heated by			
		heat	No remarkable outward damage		heet temperature; 260 °C±5 °C 5 s±0.5 s		
	7	Solder-ability	Over 95 % coverage	-	rsed terminal in solder (Sn3Ag0.5Cu)		
	'	Golder ability	Over 30 % coverage		ture of solder; 245 °C±5 °C		
				1	of immersion; 3 s±0.5 s		
					01–1 4.17		
	8	Vibration	Resistance change;	Vibration	frequency range; 10 Hz to 55 Hz		
			within ±0.5 %		peak amplitude; 1.5 mm		
			No remarkable	Rate of s	sweeping; 1 min.		
			outward damage		direction each 2 h		
					01-1 4.22		
	9	Resistance	No remarkable		Isopropyl alcohol		
		to solvent	outward damage		ture; 20 to 25 °C		
	10	112.1.	D '	_	of immersion; 60 s±5 s		
	10	High temp.	Resistance change; within ±2.0 %		ture; 150 °C±2 °C l; 0 % power.		
		exposure	WICHIN 2.0 /0	Duration			
					01-1 4.23.2		
	11	Change of	Resistance change;		3 °C(30 min.)/normal temp. (2 to 3		
		temperature	within ±0.5 %		50 °C \pm 2 °C (30 min.)/normal		
			No remarkable	temp.(2 t	o 3 min.)		
			outward damage	Number	of cycles; 5 cycles		
	12	Moisture	Resistance change;		ndition is MIL-STD-202, method		
		resistance	within ±1.0 %		power 7a and 7b not required,		
				_	4 h, 10 cycles		
	13	Bias humidity	Resistance change;	-	ture; 85 °C±2 °C.		
			within ±1.0 %		humidity; 85 %.		
				min.	s load; on time 90 min./off time 30		
				Duration	1 000 h		
	14	Endurance	Resistance change;		ture;70 °C±2 °C.		
	'	(Rated load)	within ±2.0 %	-	l; on time 90 min./off time 30 min.		
					1 000 h.		
	<u> </u>	1	1				



		Products Specific	ation; LR20 type	No.LR20-D-0005	
Items	Contents				
8.Packaging	A reel is packaged in Number of	the following box. D(mm)	Dimension (of packaging box(mm)	
	reel 1	15	Jamen sign (190	
	2	27	labe I		
	3	40		\label	
	4	48		190	

	Products Specification; LR20 type No.LR20-D-0005				
Items	Contents				
10.Notice for	1)Circumstance				
application	Please avoid the corrosive circumstances like the Ammonium, Sulfur, and Halo genic gases. These kinds of gases erode the solder plating of electrodes to trouble soldering, and cause open circuit				
	2)Soldering iron operation (inclusive of repair) Soldering iron tip shall be slowly applied so as not to float the chip.				
	Tip temperature shall be below 310 $^{\circ}$ C , time be within 3 s. each. Iron tip application to the same point shall be 2 times. For more than 2 times, please change the chip to fresh one.				
	3)Reflow soldering As shown below, pre-heat shall be 140 to 180 °C, 60 to 120 s, and reflow peak temperature be				
	255+/-5 °C, 5 s. maximum, the number of times within 2 times.				
	250 - Peak temp. ; 255+/-5 °C				
	O 220 - 150				
	100 - 140 °C ~180 °C 60 s~120 s 30 s~60 s				
	60 120 180 240				
	Time/s				
	4)Positioning The products shall be so laid out as to minimize the impact that they may receive from the bendor deflection of the board when it is divided. The products shall not be installed in places close to the dividing line or prone to strains.				
	Low-resistance resistors shall be used with care because the resistance of the wiring may be a few percent of that of the resistor.				
	5)Coating treatment Resin burying, coating, and similar operations may change the resistance greatly depending on the material used. The material shall therefore be checked before use.				
	6)Thermal effect design Please confirm thermal effects in using conditions because resistor is heat-up part.				

	<u> </u>	SHEET NO. 1/				
	Products Specification; LR20 type No.LR20-D-0005					
Items	Contents					
11.Others	1)Storing condition It is guaranteed that the product will retain normal solder-ability for one year in the standard state as per JIS C 5201-1, clause 4.2 (at temperatures between 15 and 35 °C and relative humidity between 25 and 75 %). It is not desirable that the Resistor are stored are at dusty, harmful gas, fo example hydrogen chloride and sulfate gas etc.					
	2)Power derating Even if have use it in a derating curve, in consideration of self-fever, ambien e of a resistor, heat influence from the other parts. We ask for enough load case of use in a stable state for a long term.					
	3)Shock to the Resistor When the resistors are shocked, there is danger that the resistor breaks. So in use mounter, please adjust it for no damaging to the resistor. Please avoid dropping in					
	4)RoHS directive This resistor is a product satisfying a RoHS.					
	5)For environmental protection We don't use Class I ODC and PBBOs, PBBs in a products and the process.					
	6)Off the subject of the restriction of export(COCOM) This product is off the subject of the restriction of export (COCOM) like the strate etc.	egic material				
	7)Cautions for Resistors •This specification shows the quality and performance as a resistor simple. B adoption, please evaluate and check your product in which the resistor was •This products are designed and manufactured for general standard use in ge—nic equipment (AV equipment, household electric appliances, office equipment and communication equipment, etc.).When there is a danger that a human life serious damage will occur by the fault of this products at transportation equipment as train, automobile, vessel, etc.), traffic signal, medical equipment, aerospace electric heating appliances, burning appliances, gas apparatus, rotation equipment prevention, and crime prevention equipment, please design fail—safe systems a safety, such as the following.	mounted. neral electro , information e and other pment (such equipment, ent, disaster				
	*Systems with protective circuits and a protective equipment *Systems with redundant circuits and others to do not cause danger by fa	ilure.				